

April 1988 Revised October 2000

74F8458-Bit Transparent Latch

General Description

The 74F845 bus interface latch is designed to eliminate the extra packages required to buffer existing latches and provide extra data width for wider address/data paths or buses carrying parity.

The 74F845 is functionally- and pin-compatible with AMD's Am29845.

Features

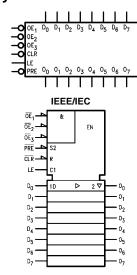
- 3-STATE outputs
- Direct replacement for AMD's Am29845

Ordering Code:

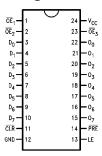
Order Number	Package Number	Package Description
74F845SC	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F845SPC	N24C	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbols



Connection Diagram



Unit Loading/Fan Out

Din Names	Description	U.L.	Input I _{IH} /I _{IL}	
Pin Names	Description	HIGH/LOW	Output I _{OH} /I _{OL}	
D ₀ –D ₇	Data Inputs	1.0/1.0	20 μA/-0.6 mA	
O ₀ -O ₇	Data Outputs	150/40	–3.0 μA/24 mA	
OE ₁ -OE ₃	Output Enables	1.0/1.0	20 μA/–0.6 mA	
LE	Latch Enable	1.0/1.0	20 μA/–0.6 mA	
CLR	Clear	1.0/1.0	20 μA/–0.6 mA	
PRE	Preset	1.0/1.0	20 μA/–0.6 mA	

Functional Description

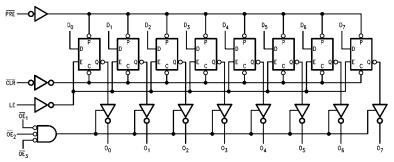
The 74F845 consists of eight D-type latches with 3-STATE outputs. The flip-flops appear transparent to the data when Latch Enable (LE) is HIGH. This allows asynchronous operation as the output transition follows the data in transition. On the LE HIGH-to-LOW transition, the data that meets the setup times is latched. Data appears on the bus when the output Enable $\overline{(\text{OE})}$ is LOW. When $\overline{\text{OE}}$ is HIGH, the bus output is in the high impedance state.

Function Table

Inputs					Internal	Output	Function
CLR	PRE	OE	LE	D	Q	0	runction
Н	Н	Н	Χ	Χ	Х	Z	High Z
Н	Н	Н	Н	L	L	Z	High Z
Н	Н	Н	Н	Н	Н	Z	High Z
Н	Н	Н	L	Χ	NC	Z	Latched
Н	Н	L	Н	L	L	L	Transparent
Н	Н	L	Н	Н	Н	Н	Transparent
Н	Н	L	L	Χ	NC	NC	Latched
Н	L	L	Χ	Χ	Н	Н	Preset
L	Н	L	Χ	Χ	L	L	Clear
L	L	L	Χ	Χ	Н	Н	Preset
L	Н	Н	L	Χ	L	Z	Latched
Н	L	Н	L	Χ	Н	Z	Latched

H = HIGH Voltage Level L = LOW Voltage Level

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Z = High Impedance NC = No Change

X = Immaterial

Absolute Maximum Ratings(Note 1)

Storage Temperature -65°C to +150°C Ambient Temperature under Bias -55°C to +125°C

Junction Temperature under Bias -55°C to +150°C V_{CC} Pin Potential to Ground Pin -0.5V to +7.0V

Input Voltage (Note 2) -0.5V to +7.0VInput Current (Note 2) -30~mA to +5.0~mA

Voltage Applied to Output

in HIGH State (with $V_{CC} = 0V$)

Standard Output -0.5V to V_{CC} 3-STATE Output -0.5V to +5.5V

Current Applied to Output

in LOW State (Max) twice the rated I_{OL} (mA)

Recommended Operating Conditions

Free Air Ambient Temperature 0°C to +70°C Supply Voltage +4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

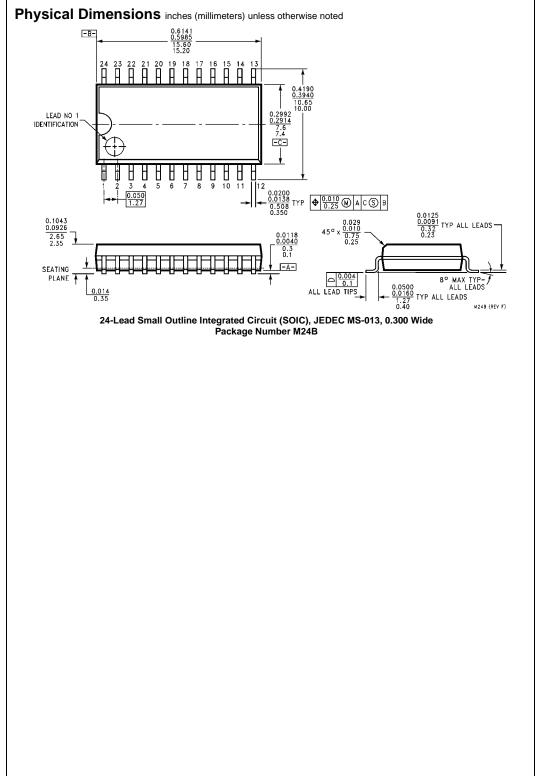
Symbol	Parameter		Min	Тур	Max	Units	V _{CC}	Conditions	
V _{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V _{IL}	Input LOW Voltage				8.0	V		Recognized as a LOW Signal	
V _{CD}	Input Clamp Diode Voltage				-1.2	V	Min	$I_{IN} = -18 \text{ mA}$	
V _{OH}	Output HIGH	10% V _{CC}	2.5					I _{OH} = -1 mA	
	Voltage	10% V _{CC}	2.4			V	Min	$I_{OH} = -3 \text{ mA}$	
		5% V _{CC}	2.7			V	IVIII	$I_{OH} = -1 \text{ mA}$	
		5% V _{CC}	2.7					$I_{OH} = -3 \text{ mA}$	
V _{OL}	Output LOW Voltage	10% V _{CC}			0.5	V	Min	I _{OL} = 24 mA	
I _{IH}	Input HIGH Current				5.0	μΑ	Max	$V_{IN} = 2.7V$	
I _{BVI}	Input HIGH Current			7.0	Δ.	Max	\/ 7.0\/		
	Breakdown Test				7.0	μΑ	IVIAX	$V_{IN} = 7.0V$	
I _{CEX}	Output HIGH				50	μА	Max	V _{OUT} = V _{CC}	
	Leakage Current								
V _{ID}	Input Leakage	4.75				V	0.0	$I_{ID} = 1.9 \mu A$	
	Test		4.75			V	0.0	All Other Pins Grounded	
I _{OD}	Output Leakage				3.75		0.0	$V_{IOD} = 150 \text{ mV}$	
	Circuit Current	ent			3.75	μΑ	0.0	All Other Pins Grounded	
I _{IL}	Input LOW Current				-0.6	mA	Max	$V_{IN} = 0.5V$	
I _{OZH}	Output Leakage Current				50	μΑ	Max	V _{OUT} = 2.7V	
l _{OZL}	Output Leakage Current				-50	μΑ	Max	V _{OUT} = 0.5V	
Ios	Output Short-Circuit Current		-60		-150	mA	Max	$V_{OUT} = 0V$	
I _{ZZ}	Bus Drainage Test				500	μΑ	0.0V	V _{OUT} = 5.25V	
I _{CCZ}	Power Supply Current			63	85	mA	Max	$V_O = HIGH Z$	

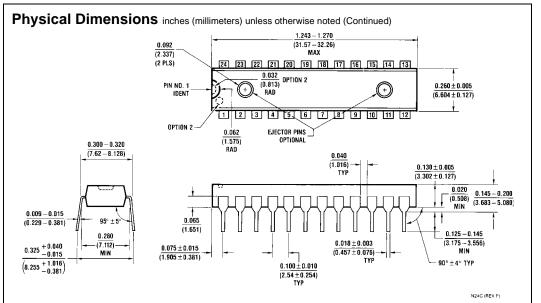
AC Electrical Characteristics

Symbol	Parameter	$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$			T_A = 0°C to +70°C V_{CC} = +5.0V C_L = 50 pF		Units
		Min	Тур	Max	Min	Max	
t _{PLH}	Propagation Delay	2.5	4.8	8.0	2.0	9.0	ns
t _{PHL}	D _n to O _n	1.5	3.6	6.5	1.5	7.0	ns
t _{PLH}	Propagation Delay	5.0	8.1	12.0	4.5	13.5	ns
t _{PHL}	LE to O _n	2.0	4.4	7.5	2.0	8.0	
t _{PLH}	Propagation Delay PRE to On	3.0	5.9	10.0	2.5	11.0	ns
t _{PHL}	Propagation Delay CLR to On	3.0	6.5	10.0	2.5	11.0	ns
t _{PZH}	Output Enable Time	2.5	5.8	9.5	2.0	10.5	ns
t _{PZL}	OE to O _n	2.5	7.6	12.0	2.0	13.0	
t _{PHZ}	Output Disable Time	1.0	3.1	7.5	1.0	8.5	ns
t _{PLZ}	OE to O _n	1.0	2.8	6.5	1.0	7.5	115

AC Operating Requirements

		T _A = +25°C		T _A = 0°C to +70°C		
Symbol	Parameter		$\mathbf{V_{CC}} = +5.0\mathbf{V}$		$V_{CC} = +5.0V$	
		Min	Max	Min	Max	
t _S (H)	Setup Time, HIGH or LOW	2.0		2.5		ns
t _S (L)	D _n to LE	2.0		2.5		115
t _H (H)	Hold Time, HIGH or LOW	2.5		3.0		ns
t _H (L)	D _n to LE	3.0		3.5		115
t _W (H)	LE Pulse Width, HIGH	4.0		4.0		ns
t _W (L)	PRE Pulse Width, LOW	5.0		5.0		ns
t _W (L)	CLR Pulse Width, LOW	5.0		5.0		ns
t _{REC}	PRE Recovery Time	10.0		10.0		ns
t _{REC}	CLR Recovery Time	12.0		13.0		ns





24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N24C

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